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(71) Applicant (for all designated States except US): **DOW CORNING CORPORATION [US/US];** 2200 West Salzburg Road, Midland, MI 48686-0994 (US).

(72) Inventors; and

(75) Inventors/Applicants (for US only): **BHAGWAGAR,** Dorab, Edul [IN/US]; 2850 Churchill Lane, Saginaw, MI 48603 (US). **DURFEE,** Loren [US/US]; 1807 Burlington Drive, Midland, MI 48642 (US). **LUTZ,** Michael [US/US]; 408 East Saiko Road, Hope, MI 48628 (US). **MITCHELL,** Timothy [US/US]; 508 Clarion Street, Clio, MI 48420 (US).

(74) Common Representative: **SCADUTO,** Patricia, M.; Dow Corning Corporation, Intellectual Property Dept., Mail CO1232, 2200 West Salzburg Road, Midland, MI 48686-0994 (US).

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(54) Title: **SOLVENTLESS SILICONE PRESSURE SENSITIVE ADHESIVES WITH IMPROVED HIGH TEMPERATURE COHESIVE STRENGTH**

(57) Abstract: This invention relates to silicone compositions suitable for forming pressure sensitive adhesives. More particularly, the present invention relates to solventless curable PSA compositions suitable for forming pressure sensitive adhesive compositions having improved high temperature cohesive strength while maintaining good tack and adhesive properties.

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